

N-channel 60 V, 0.22 Ω typ., 38 A, STripFET™ II Power MOSFET in a TO-220 package

Datasheet - production data

Features

Order code	V _{DS}	R _{DS(on)}	I _D
STP45NF06	60 V	$0.028~\Omega$	38 A

- Typical $R_{DS(on)} = 0.022 \Omega$
- Exceptional dv/dt capability
- 100% avalanche tested
- Standard threshold drive

Applications

Switching application

Description

This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

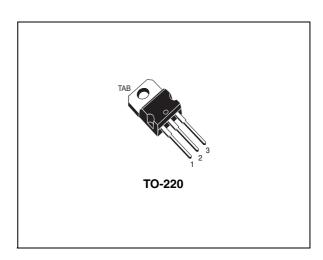


Figure 1. Internal schematic diagram

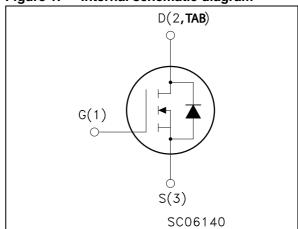


Table 1. Device summary

Order code	Marking	Package	Packaging
STP45NF06	45NF06	TO-220	Tube

Contents STP45NF06

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STP45NF06 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	60	V
V _{DGR}	Drain-gate voltage (R _{GS} =20 kΩ)	60	V
V _{GS}	Gate-source voltage	± 20	V
I _D	Drain current (continuous) at T _C = 25 °C	38	Α
I _D	Drain current (continuous) at T _C = 100 °C	26	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	152	Α
P _{TOT}	Total dissipation at T _C = 25 °C	80	W
	Derating factor	0.53	W/°C
dv/dt (2)	Peak diode recovery voltage slope	7	V/ns
T _{stg}	Storage temperature	- 65 to 175	°C
Tj	Max. operating junction temperature	175	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.88	°C/W
R _{thj-amb} ⁽¹⁾	Thermal resistance junction-ambient max	35	°C/W

^{1.} When mounted on 1 inch² FR-4, 2 Oz copper board.

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by T_{jmax})	38	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$; $V_{DD} = 50$ V)	135	mJ

^{2.} $I_{SD} \leq$ 38 A, di/dt \leq 300 A/µs; $V_{DS(peak)} < V_{(BR)DSS}$, V_{DD} =80 % $V_{(BR)DSS}$

Electrical characteristics STP45NF06

2 Electrical characteristics

(T_C = 25 $^{\circ}$ C unless otherwise specified).

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \text{ mA}, V_{GS} = 0$	60			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 60 V V _{DS} = 60 V, T _C =125 °C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	3	4	٧
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 19 A		0.022	0.028	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward trasconductance	V _{DS} >I _{D(on)} *R _{DS(on)max} , I _D =19 A	-	24		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	1730 215 63		pF pF pF
Q _g Q _{gs} Q _{gs}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} = 48 V, I _D = 38 A, V _{GS} = 10 V	-	43 9 15	58	ns ns ns

^{1.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Voltage rise time	$V_{DD} = 30 \text{ V}, I_{D} = 19 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	20 100	-	ns ns
t _{d(off)}	Turn-off delay time Fall time	(see <i>Figure 14</i>)	-	50 20	-	ns ns
t _{d(off)} t _f t _c	Off-voltage rise time Fall time Cross-over time	V_{clamp} = 48 V, I_D = 38 A, R_G = 4.7 Ω , V_{GS} = 10 V (see <i>Figure 16</i>)	-	45 42 60	-	ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		_		38	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		152	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 38 A, V _{GS} = 0	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 38 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		95		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 100 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	260		μC
I _{RRM}	Reverse recovery current	(see Figure 16)		5.5		Α

- 1. Pulsed: pulse duration = $300 \mu s$, duty cycle 1.5%
- 2. Pulse width limited by safe operating area.

Electrical characteristics STP45NF06

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

10¹ 100μs 100μs 100πs 100πs

Figure 3. Thermal impedance

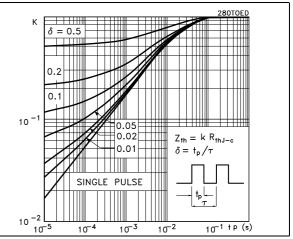


Figure 4. Output characteristics

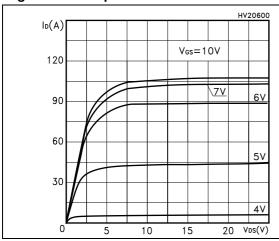


Figure 5. Transfer characteristics

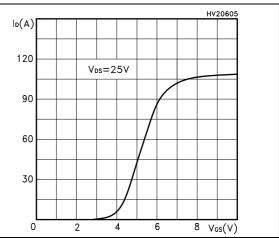


Figure 6. Transconductance

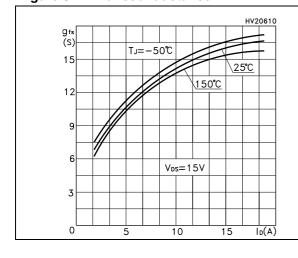
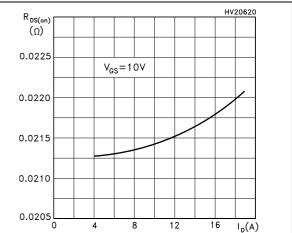


Figure 7. Static drain-source on-resistance



 $V_{DS}(V)$

 $V_{GS}(V)$ C(pF) f=1MHz $V_{GS} = 0V$ 12 2000 $V_{DD}=48V$ Cis ID=38A 1500 1000 6 500 0 10 20 30 40

Figure 8. Gate charge vs gate-source voltage Figure 9. **Capacitance variations**

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on-resistance vs vs temperature

30

40

50 Qg(nC)

20

10

temperature

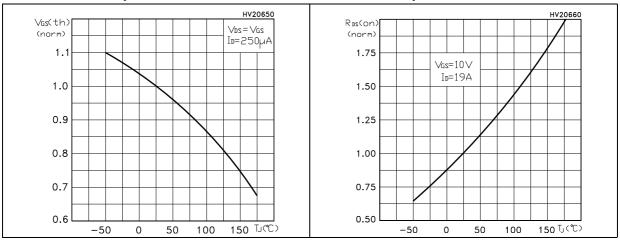
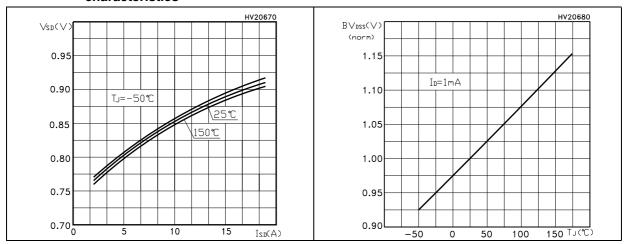


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized B_{VDSS} vs temperature



Test circuits STP45NF06

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

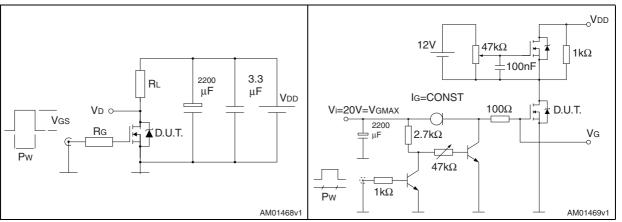


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

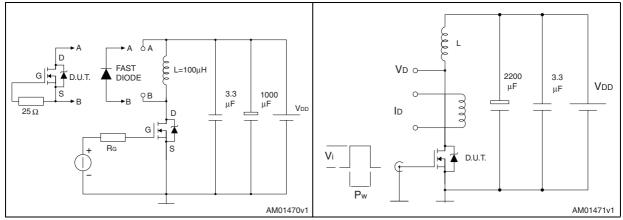
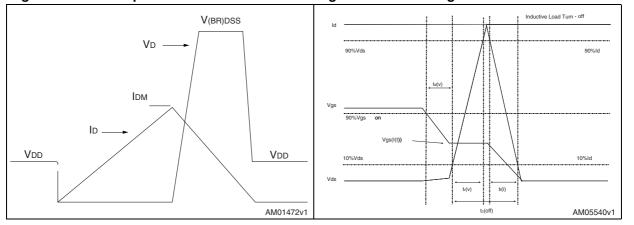


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 9. TO-220 type A mechanical data

Dim		mm	
Dim. —	Min.	Тур.	Max.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

Figure 20. TO-220 type A drawing

Revision history STP45NF06

5 Revision history

Table 10. Revision history

Date	Revision	Changes
09-Sep-2004	1	Preliminary version.
04-Feb-2005	2	Complete version.
17-Aug-2006	3	New template. No content change.
13-Nov-2006	4	Inserted new value.
05-Jul-2010	5	Updated Section 2.1: Electrical characteristics (curves).
19-Dec-2012	6	Updated: Section 4: Package mechanical data

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